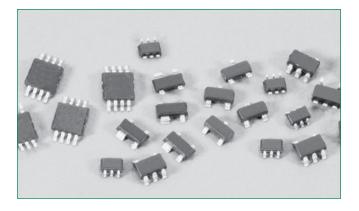
SP05 Series - 30pF 30kV Unidirectional TVS Array











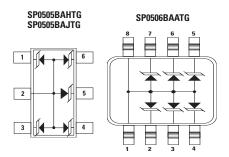
Pinout

SP0502BAHTG

SP0502BAJTG SP0504BAJTG 3 2 2

SP0503BAHTG

SP0504BAHTG



Description

This surface mount family of arrays suppress ESD and other transient overvoltage events. Used to meet the International Electrotechnical Compatibility (IEC transient immunity standards IEC 61000-4-2 for Electrostatic Discharge Requirements), these components can help protect sensitive digital or analog input circuits on data, signal, or control lines with voltage levels up to 5VDC.

The monolithic silicon arrays are comprised of specially designed structures for transient voltage suppression (TVS). The size and shape of these structures have be tailored for transient protection. Compared to MOVs, this diode array provides a lower clamping voltage and lower off-state capacitance.

Features

- An Array of 2, 3, 4, 5 or 6 TVS Avalanche Diodes in a ultra small SC70, SOT-23, SOT-143 or MSOP packages
- ESD Capability Standards
 - IEC 61000-4-2, Direct Discharge 30kV (Level 4)
 - IEC 61000-4-2, Air Discharge............. 30kV (Level 4)
 - MIL STD 883 3015.7.....30kV
- Input Protection for Applications Up to 5VDC
- Fast Response Time<1ns
- Low Input Capacitance......30pF Typical
- Operating Temperature Range.....-40°C to 125°C
- Moisture Sensitivity Level (MSL-1)

Applications

- Mobile phone handsets
- Personal Digital Assistants (PDA)
- Portable handheld equipment (Laptop, Palmtop computers)
- · Computer port, keyboard (USB1.1)
- Digital still cameras
- Digital video cameras
- MP3 players

Additional Information







Resources



Samples

Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated

TVS Diode Array

Absolute Maximum Ratings

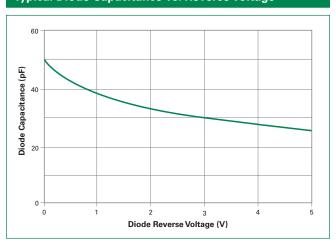
Symbol	Parameter	Rating	Units
P _{PK}	Peak Pulse Power (t _p =8/20µs)	25	W
I _{PP}	Peak Pulse Current (t _p =8/20µs)	3	А
T _{OP}	Operating Temperature	-40 to 125	°C
T _{STOR}	Storage Temperature	-55 to 150	°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the component. This is a stress only rating and operation of the component at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Electrical Characteristics T_A = +25°C, Unless Otherwise Specified

Parameter	Test Conditions	Min	Тур	Max	Units
Reverse Standoff Voltage	I _R ≤ 1μA			5.5	V
Reverse Standoff Leakage Current	V = 5.0V		1	100	nA
Signal Clamp Voltage					
Positive	I = 1mA	6.0		8.5	V
Negative	I = 10mA	-1.2	-0.8	-0.4	V
Clamp Voltage during ESD					
MILSTD-883 Method 3015 (HBM) test					
+ 8kV			12		V
- 8kV			-8		V
ESD Test Level (1)					-
IEC-61000-4-2, Contact discharge		30			kV
MIL-STD-883 Method 3015 (HBM)		30			kV
Capacitance	2.5V @ 1MHz		30		pF
Turn on/off Time			<1		ns
Diode Dynamic Resistance					-
Forward Conduction			1.0		Ω
Reverse Conduction			1.4		Ω

Typical Diode Capacitance vs. Reverse Voltage



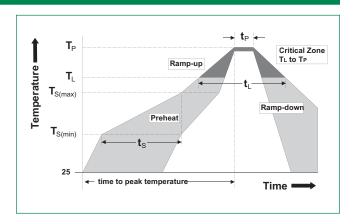
Note:

1. ESD voltage applied between channel pins and ground, one pin at a time; all other channel pins are open; all ground pins are grounded.

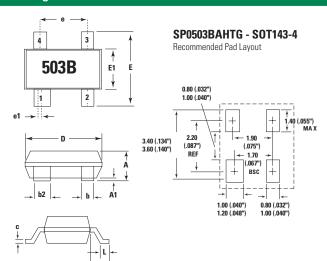
TVS Diode Array

Soldering Parameters

Reflow Cond	lition	Pb – Free assembly
	-Temperature Min (T _{s(min)})	150°C
Pre Heat	-Temperature Max (T _{s(max)})	200°C
	-Time (min to max) (t _s)	60 – 180 secs
Average ram	p up rate (Liquidus) Temp (T _L) to peak	5°C/second max
T _{S(max)} to T _L - Ramp-up Rate		5°C/second max
D (1	-Temperature (T _L) (Liquidus)	217°C
Reflow	-Temperature (t _L)	60 – 150 seconds
Peak Temper	rature (T _p)	260 ^{+0/-5} °C
Time within	5°C of actual peak Temperature (t _p)	20 - 40 seconds
Ramp-down Rate		5°C/second max
Time 25°C to peak Temperature (T _p)		8 minutes Max.
Do not exce	ed	260°C



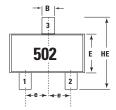
Package Dimensions — SOT143



Package	SOT143-4				
Pins		4			
JEDEC		TO-	-253		
Complete	Millin	neters	Inc	hes	
Symbol	Min	Max	Min	Max	
Α	0.8	1.22	0.03	0.048	
A1	0.05	0.15	0.002	0.006	
b	0.30	0.50	0.012	0.020	
b2	0.76	0.89	0.030	0.035	
С	0.08	0.20	0.003	0.008	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.082	0.104	
E1	1.20	1.40	0.047	0.055	
е	1.92	BSC	0.076	BSC	
e1	0.20 BSC		0.008	BSC	
L	0.4	0.6	0.016	0.024	
L1	0.550 REF		0.022	2 REF	



Package Dimensions — SC70

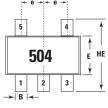


SP0502BAJTG - SC70-3

Package	SC70-3				
Pins	3				
JEDEC		MO-203			
Complete	Millin	neters	Inc	hes	
Symbol	Min	Max	Min	Max	
Α	0.80	1.10	0.031	0.043	
A1	0.00	0.10	0.00	0.004	
A2	0.70	1.00	0.028	0.039	
В	0.15	0.30	0.006	0.012	
С	0.08	0.25	0.003	0.010	
D	1.85	2.25	0.073	0.089	
E	1.15	1.35	0.045	0.053	
е	0.66	BSC	0.026	BSC	
HE	2.00	2.40	0.079	0.094	
L	0.26	0.46	0.010	0.018	

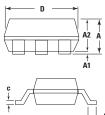




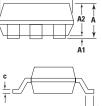


SP0504BAJTG - SC70-5

Package	SC70-5				
Pins		5			
JEDEC		МО	-203		
Cb I	Millin	neters	Inc	hes	
Symbol	Min	Max	Min	Max	
Α	0.80	1.10	0.031	0.043	
A1	0.00	0.10	0.00	0.004	
A2	0.70	1.00	0.028	0.039	
В	0.15	0.30	0.006	0.012	
С	0.08	0.25	0.003	0.010	
D	1.85	2.25	0.073	0.089	
E	1.15	1.35	0.045	0.053	
е	0.65	0.65 BSC 0.026 BSC			
HE	2.00	2.40	0.079	0.094	
L	0.26	0.46	0.010	0.018	

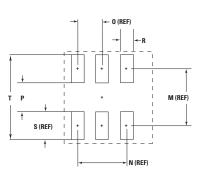


6 5 5	4		_
505	;	E V	HE
1 2 2 → B ←	3		
D -		1 1	



SP0505BAJTG - SC70-6

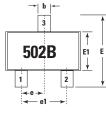
Recommended Pad Layout

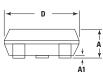


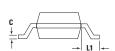
Package		SC70-6			
Pins	6				
JEDEC		MO-203			
Complete	Millin	neters	Inc	hes	
Symbol	Min	Max	Min	Max	
Α	0.80	1.10	0.031	0.043	
A1	0.00	0.10	0.00	0.004	
A2	0.70	1.00	0.028	0.039	
В	0.15	0.30	0.006	0.012	
С	0.08	0.25	0.003	0.010	
D	1.85	2.25	0.073	0.089	
E	1.15	1.35	0.045	0.053	
е	0.65	BSC	0.026	BSC	
HE	2.00	2.40	0.079	0.094	
L	0.26	0.46	0.010	0.018	
M	-	1.60	-	0.063	
N	-	1.30	-	0.051	
0	-	0.65	-	0.026	
Р	-	0.70	-	0.028	
R	-	0.35	-	0.014	
S	-	0.90	-	0.035	
Т	-	2.50	-	0.098	



Package Dimensions — SOT23

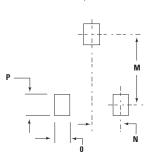




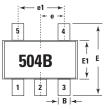


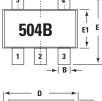
SP0502BAHTG - S0T23-3

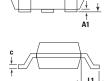
Recommended Pad Layout



Package	SOT23-3			
Pins	3			
JEDEC			-236	
Symbol	Millin	neters	Inc	hes
Зуппоп	Min	Max	Min	Max
Α	0.89	1.12	0.035	0.044
A1	0.01	0.1	0.0004	0.004
b	0.3	0.5	0.012	0.020
С	0.08	0.2	0.003	0.008
D	2.8	3.04	0.110	0.120
E	2.1	2.64	0.083	0.104
E1	1.2	1.4	0.047	0.055
е	0.95	BSC	0.038	BSC
e1	1.90 BSC		0.075	BSC
L1	0.54	0.54 REF		I REF
M		2.29		0.090
N		0.95		0.038
0		0.78		0.030TYP
Р		0.78		0.030TYP

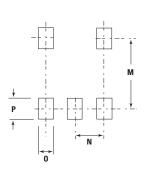




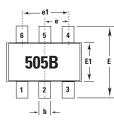


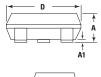
SP0504BAHTG - S0T23-5

Recommended Pad Layout



Package	SOT23-5				
Pins		5			
JEDEC		МО	-178		
Symbol	Millin	neters	Inc	hes	
Symbol	Min	Max	Min	Max	
Α	-	1.45	-	0.057	
A1	0	0.15	0	0.006	
b	0.3	0.5	0.012	0.020	
С	0.08	0.22	0.003	0.009	
D	2.75	3.05	0.108	0.120	
E	2.6	3.0	0.102	0.118	
E1	1.45	1.75	0.057	0.069	
е	0.95	BSC	0.038	BSC	
e1	1.90 BSC		0.075	BSC	
L1	0.60	REF	0.024	1 REF	
M		2.59		.102	
N		0.95		.038	
0		0.69		.027TYP	
Р		0.99		.039TYP	

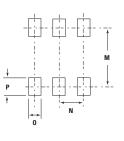






SP0505BAHTG - S0T23-6

Recommended Pad Layout

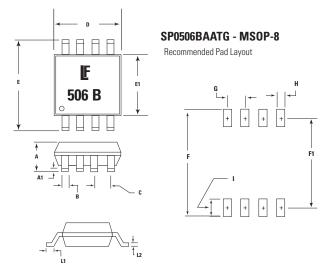


Package		SOT23-6			
Pins	6				
JEDEC		MO	-178		
Combal	Millin	neters	Inc	hes	
Symbol	Min	Max	Min	Max	
Α	-	1.45	-	0.057	
A1	0	0.15	0	0.006	
b	0.3	0.5	0.012	0.020	
С	0.08	0.22	0.003	0.009	
D	2.75	3.05	0.108	0.120	
E	2.6	3.0	0.102	0.118	
E1	1.45	1.75	0.057	0.069	
е	0.95 BSC		0.038	BSC	
e1	1.90 BSC		0.075	BSC	
L1	0.60	REF	0.024	1 REF	
M		2.59		.102	
N		0.95		0.038	
0		0.69		.027TYP	
Р		0.99		.039TYP	



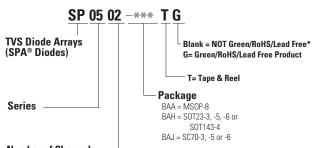
General Purpose ESD Protection - SP05 Series

Package Dimensions — MSOP



Package	MSOP				
Pins	8				
JEDEC		MO-187			
Symbol	Millin	neters	Inc	hes	
Syllibol	Min	Max	Min	Max	
D	2.90	3.10	0.114	.122	
E	4.78	4.98	.188	.196	
E1	2.90	3.10	.114	.122	
A	0.87	1.17	.034	.046	
A1	0.05	0.25	.002	0.010	
В	-	0.30TYP	-	0.012TYP	
С	-	0.65TYP	-	0.026TYP	
L1	0.52	0.54	0.020	0.021	
L2	-	0.18TYP	-	.007TYP	
F	-	5.28	-	.208	
F1	-	4.24	-	.167	
G	-	0.65	-	0.026	
Н	-	0.38	-	.015	
I	-	1.04	-	.041	

Part Numbering System



Number of Channels

- 02 = 2 channel (SC70-3, SOT23 packages)
- 03 = 3 channel (SOT143 package) 04 = 4 channel (SC70-5, SOT23-5 package)
- 05 = 5 channel (SC70-6, SOT23-6 packages)
- 06 = 6 channel (MSOP-8 package)

Ordering Information

Part Number	СН	Package Type	Quantity Per Reel
SP0502BAHTG	2	SOT23-3	3000
SP0503BAHTG	3	SOT143-4	3000
SP0504BAHTG	4	SOT23-5	3000
SP0505BAHTG	5	SOT23-6	3000
SP0506BAATG	6	MSOP-8	4000
SP0502BAJTG	2	SC70-3	3000
SP0504BAJTG	4	SC70-5	3000
SP0505BAJTG	5	SC70-6	3000

^{*}NOTE: To order NON-Green/RoHS/Lead Free version of product, remove "G" at the end of part number.

Product Characteristics

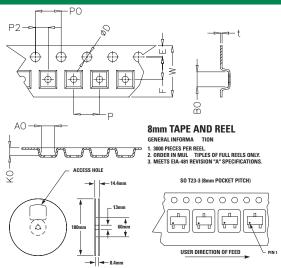
Lead Plating	"G" Green version - Matte Tin (Sn)
Lead Material	Copper / Iron Alloy
Lead Coplanarity	0.004 inches (0.102mm)
Substrate Material	Silicon
Body Material	Molded Compound
Flammability	UL Recognized compound meeting flammability rating V-0

- Dimensions include solder plating.
 Dimensions are exclusive of mold flash & metal burr.
- Blo is facing up for mold and facing down for trim/form, i.e. reverse trim/form.
 Package surface matte finish VDI 11-13.



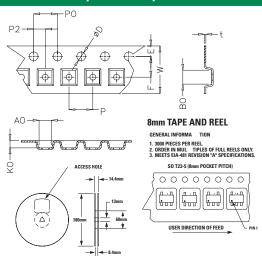
General Purpose ESD Protection - SP05 Series

Embossed Carrier Tape & Reel Specification — SOT23-3



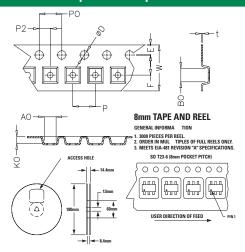
Complete	Millin	Millimetres		Inches	
Symbol	Min	Max	Min	Max	
E	1.65	1.85	0.065	0.073	
F	3.40	3.60	0.134	0.142	
P2	1.90	2.10	0.075	0.083	
D	1.40	1.60	0.055	0.063	
P0	3.90	4.10	0.154	0.161	
W	7.70	8.30	0.303	0.327	
Р	3.90	4.10	0.154	0.161	
A0	3.05	3.25	0.120	0.128	
В0	2.67	2.87	0.105	0.113	
K0	1.12	1.32	0.044	0.052	
t	0.22	0.24	0.009	0.009	

Embossed Carrier Tape & Reel Specification — SOT23-5



Compleal	Millin	netres	Inc	hes
Symbol	Min	Max	Min	Max
E	1.65	1.85	0.065	0.073
F	3.40	3.60	0.134	0.142
P2	1.90	2.10	0.075	0.083
D	1.40	1.60	0.055	0.063
P0	3.90	4.10	0.154	0.161
W	7.70	8.30	0.303	0.327
Р	3.90	4.10	0.154	0.161
A0	3.05	3.25	0.120	0.128
В0	2.67	2.87	0.105	0.113
K0	1.12	1.32	0.044	0.052
t	0.22	0.24	0.009	0.009

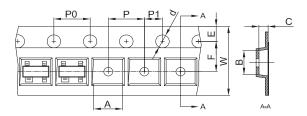
Embossed Carrier Tape & Reel Specification — SOT23-6

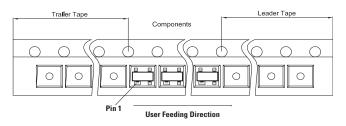


Symbol	Millin	netres	Inc	hes
	Min	Max	Min	Max
E	1.65	1.85	0.065	0.073
F	3.40	3.60	0.134	0.142
P2	1.90	2.10	0.075	0.083
D	1.40	1.60	0.055	0.063
P0	3.90	4.10	0.154	0.161
W	7.70	8.30	0.303	0.327
P	3.90	4.10	0.154	0.161
A0	3.05	3.25	0.120	0.128
В0	2.67	2.87	0.105	0.113
K0	1.12	1.32	0.044	0.052
t	0.22	0.24	0.009	0.009



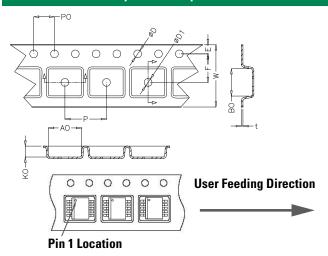
Embossed Carrier Tape & Reel Specification — SOT143-4





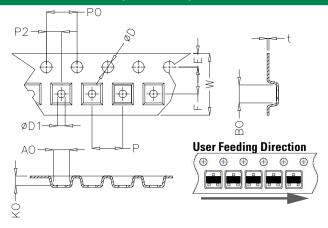
Complete	Millin	netres	Inches	
Symbol	Min	Max	Min	Max
Α	3.09	3.09	0.122	0.130
В	2.70	2.90	1.106	0.114
С	1.21	1.41	0.048	0.056
d	1.40	1.60	0.055	0.102
E	1.65	0.85	0.065	0.073
F	3.45	3.65	0.133	0.142
P0	4.10	3.90	0.154	0.161
Р	4.10	3.90	0.154	0.161
P1	1.90	2.10	0.075	0.083
W	7.90	8.10	0.311	0.319

Embossed Carrier Tape & Reel Specification — MSOP-8



Complete	Millin	netres	Inches	
Symbol	Min	Max	Min	Max
E	1.65	1.85	0.065	0.073
F	5.40	5.60	0.213	0.220
D	1.50	1.60	0.059	0.063
D1	1.50	Min	0.059 Min	
P0	3.90	4.10	0.154	0.161
W	11.70	12.30	0.461	0.484
Р	7.90	8.10	0.311	0.319
A0	5.20	5.40	0.205	0.213
B0	3.30	3.40	0.126	0.134
K0	1.20	1.40	0.047	0.055
t	0.30 ±	± 0.05	0.012±	0.002

Embossed Carrier Tape & Reel Specification — SC70-3

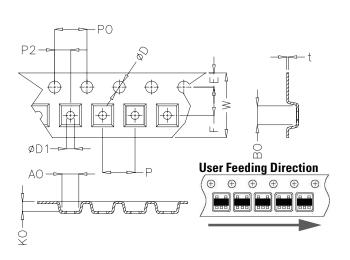


Cumbal	Millimetres		Inches	
Symbol	Min	Max	Min	Max
E	1.65	1.85	0.064	0.073
F	3.45	3.55	0.135	0.139
P2	1.95	2.05	0.077	0.081
D	1.40	1.60	0.055	0.063
D1	1.00	1.25	0.039	0.049
P0	3.90	4.10	0.154	0.161
W	7.70	8.10	0.303	0.318
P	3.90	4.10	0.153	0.161
A0	2.14	2.34	0.084	0.092
В0	2.24	2.44	0.088	0.096
K0	1.12	1.32	0.044	0.052
t	0.27	Max	0.010	Max



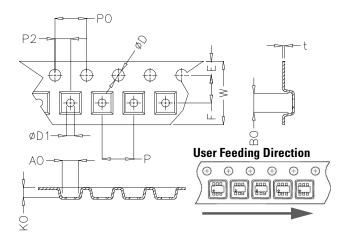
General Purpose ESD Protection - SP05 Series

Embossed Carrier Tape & Reel Specification — SC70-5



Symbol	Millin	netres	Inc	hes
Symbol	Min	Max	Min	Max
E	1.65	1.85	0.064	0.073
F	3.45	3.55	0.135	0.139
P2	1.95	2.05	0.077	0.081
D	1.40	1.60	0.055	0.063
D1	1.00	1.25	0.039	0.049
P0	3.90	4.10	0.154	0.161
W	7.70	8.10	0.303	0.318
Р	3.90	4.10	0.153	0.161
A0	2.14	2.34	0.084	0.092
В0	2.24	2.44	0.088	0.096
K0	1.12	1.32	0.044	0.052
t	0.27	Max	0.010	Max

Embossed Carrier Tape & Reel Specification — SC70--6



Symbol	Millin	netres	Inches	
Symbol	Min	Max	Min	Max
E	1.65	1.85	0.064	0.073
F	3.45	3.55	0.135	0.139
P2	1.95	2.05	0.077	0.081
D	1.40	1.60	0.055	0.063
D1	1.00	1.25	0.039	0.049
P0	3.90	4.10	0.154	0.161
W	7.70	8.10	0.303	0.318
Р	3.90	4.10	0.153	0.161
A0	2.14	2.34	0.084	0.092
В0	2.24	2.44	0.088	0.096
K0	1.12	1.32	0.044	0.052
t	0.27	Max	0.010	Max

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